

ZPMV2.E357163 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

KING CREDIE TECHNOLOGY LTD
Unit A1, 7/F, Cheuk Nang Plaza
250 Hennessy Road
Waichai, HONG KONG

E357163

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max	Solder		Max	Meets		C
	Min	Edge			Area	Limits	Oper	Flame	UL796	T	
	mm(in)	mm(in)			Diam	C	sec	C	Class	DSR	I
					mm(in)						
Multilayer printed wiring boards.											
MJD-M	0.09 (0.004)	0.09 (0.004)	18 (0.71) Int:102	DS	50.8 (2.0)	288	20	130	V-0	All	*
Single layer printed wiring boards.											
MJD-D	0.09 (0.004)	0.09 (0.004)	18 (0.71)	DS	50.8 (2.0)	288	20	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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